

ROW C-

row B—

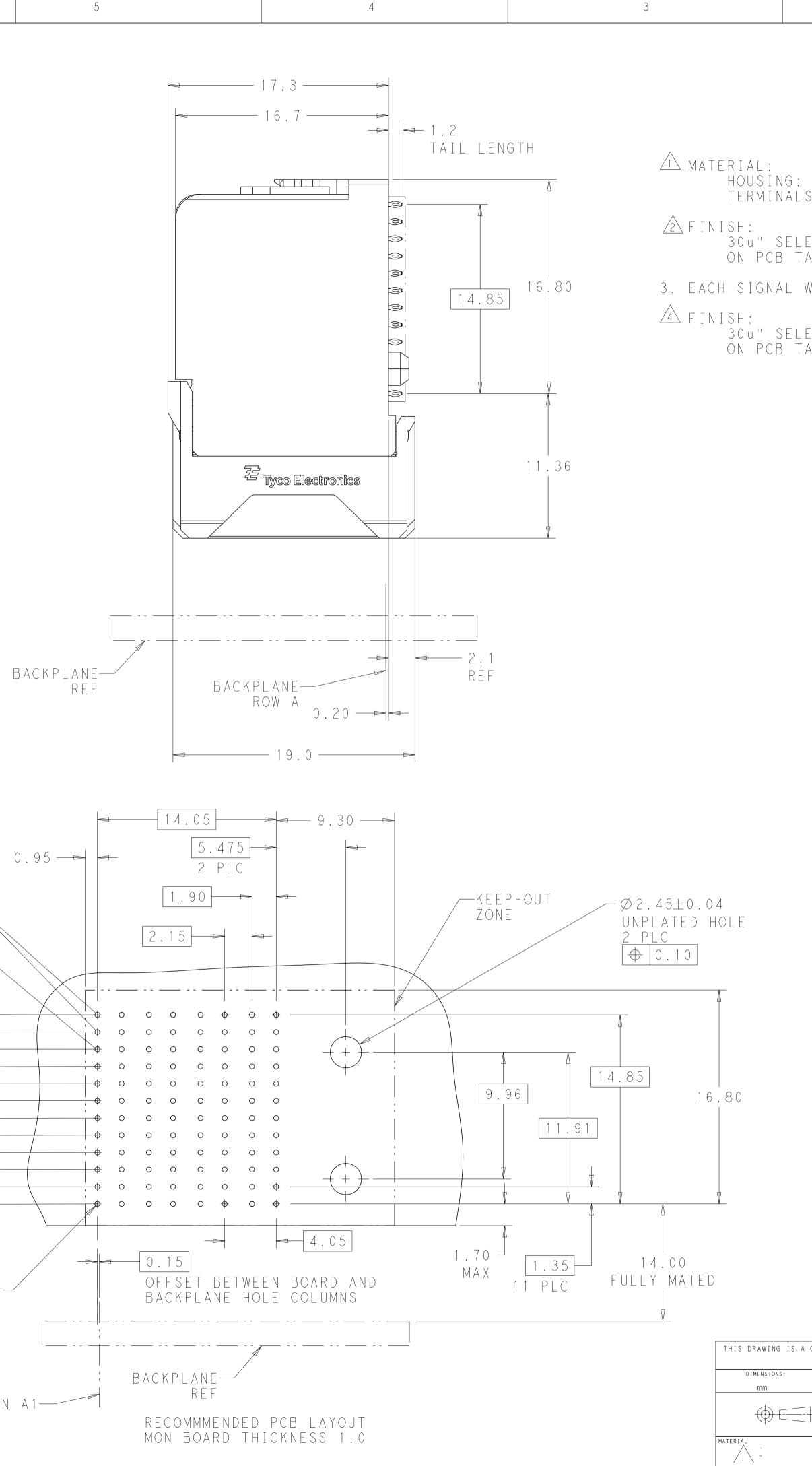
ROW A—

6

Ø0.39±0.05-Plated thru hole 120 plc

> Ø0.48±0.013 DRILL HOLE 120 PLC ⊕0.10

> > BACKPLANE PIN A1----



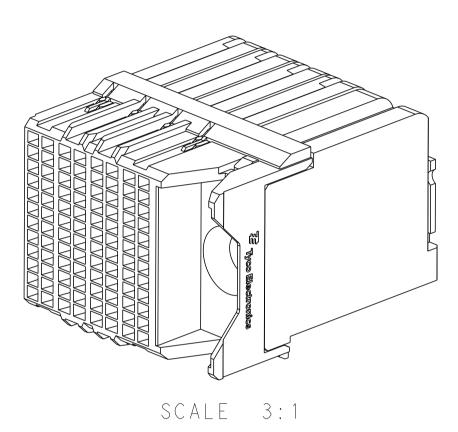
	2			1			
LOC	DIST			REVISIONS			
A D	00	Р	LTR	DESCRIPTION	DATE	DWN	APVD
			А	REVISED PER ECO-12-004765	28NOV2012	КН	DD

HOUSING: LCP, GLASS FILLED, UL94V-0 TERMINALS: HIGH PERFORMANCE COPPER ALLOY

30 u" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL

3. EACH SIGNAL WAFER CONTAINS 2 COLUMNS OF TERMINALS

30u" SELECTIVE GOLD IN CONTACT AREA, SELECTIVE TIN-LEAD ON PCB TAILS, NICKEL OVERALL



	4	2132465-5		
	2	2132465-1		
	FINISH	PART NUMBER		
CONTROLLED DOCUMENT. M. HORNING CHK 23NOV2010 D. DIXON	≤ TE	TE Connectivity		
OTHERWISE SPECIFIED: APVD 23NOV2010	IMPACT, 4 PR, 8 COL, DAUGHTERCARD, RIGHT GUIDED SIGNAL MODULE 0.39 EYELET, ORTHOGONAL			
	size cage code drawing no 4100779 C -2132465	RESTRICTED TO		
- CUSTOMER DRAWING	SCALE	5.1 SHEET OF REV A		

D

В

单击下面可查看定价,库存,交付和生命周期等信息

>>TE Connectivity(泰科)